SN54HC7032, SN74HC7032 QUADRUPLE POSITIVE-OR GATES WITH SCHMITT-TRIGGER INPL

SCLS036E - MARCH 1984 - REVISED NOVEMBER 2004

- Wide Operating Voltage Range of 2 V to 6 V
- **Operation From Very Slow Input** Transitions
- Same Pinouts as 'HC32
- **Outputs Can Drive Up To 10 LSTTL Loads**
- Low Power Consumption, 20-µA Max ICC
- Typical t_{pd} = 14 ns
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 μ A Max
- **Temperature-Compensated Threshold** Levels
- **High Noise Immunity**

description/ordering information

In these devices, each circuit functions as a quadruple OR gate. They perform the Boolean function $Y = \overline{A \bullet B}$ or Y = A + B in positive logic. However, because of the Schmitt action, the inputs have different input threshold levels for positive- and negative-going signals.

These circuits are temperature compensated and can be triggered from the slowest of input ramps and still give clean jitter-free output signals.

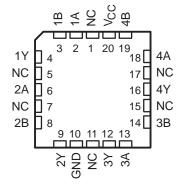
SN74HC7032.		N, OR VIEW)	NS PACKAGE
1A [1	J ₁₄	Vcc
1A [1B [2	13] V _{CC}] 4B
1Y [3	12] 4A
2A [4	11	4Y
2B [5	10] 3B

SN54HC7032 ... J OR W PACKAGE

9 3A 2Y 6 7 8 3Y

GND

SN54HC7032 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

TA	PACK	AGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
	PDIP – N	Tube of 25	SN74HC7032N	SN74HC7032N		
–40°C to 85°C		Tube of 50	SN74HC7032D			
	SOIC – D	Reel of 2500	SN74HC7032DR	HC7032		
		Reel of 250	SN74HC7032DT			
	SOP – NS	Reel of 2000	SN74HC7032NSR	HC7032		
	CDIP – J	Tube of 25	SNJ54HC7032J	SNJ54HC7032J		
–55°C to 125°C	CFP – W	Tube of 150	SNJ54HC7032W	SNJ54HC7032W		
	LCCC – FK	Tube of 55	SNJ54HC7032FK	SNJ54HC7032FK		

ORDERING INFORMATION

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each gate)									
INP	UTS	OUTPUT							
Α	В	Y							
Н	Х	Н							
Х	Н	Н							
1	1	1							



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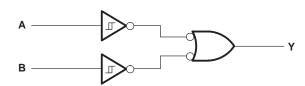


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SN54HC7032, SN74HC7032 **QUADRUPLÉ POSITIVE-OR GATES** WITH SCHMITT-TRIGGER INPUTS

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logic diagram, each gate (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note	∋ 1) ±20 mA
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CC}) (see	Note 1) ±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC}) \dots$	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): D package thermal impedance, θ_{JA} (see Note 2): D package thermal impedance θ_{JA} (see Note 2): D pac	ckage 86°C/W
N pao	ckage 80°C/W
NS p	ackage
Storage temperature range, T _{stg}	−65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		SN54HC7032			SN	32		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	2	6 5	6	2	5	6	V
VI	Input voltage	0	0,6%	VCC	0		VCC	V
VO	Output voltage	0		V _{CC}	0		VCC	V
Т _А	Operating free-air temperature	-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics	over	recommended	operating	free-air	temperature	range	(unless
otherwise noted)					-	•	

				Т	A = 25°C)	SN54H	C7032	SN74H	C7032		
PARAMETER	TEST CO	ONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
			2 V	0.7	1.2	1.5	0.7	1.5	0.7	1.5		
VT+	V _{T+}		4.5 V	1.55	2.5	3.15	1.55	3.15	1.55	3.15	V	
			6 V	2.1	3.3	4.2	2.1	4.2	2.1	4.2		
			2 V	0.3	0.6	1	0.3	1	0.3	1		
VT−			4.5 V	0.9	1.6	2.45	0.9	2.45	0.9	2.45	V	
		6 V	1.2	2	3.2	1.2	3.2	1.2	3.2			
			2 V	0.2	0.6	1.2	0.2	1.2	0.2	1.2		
$V_{T+} - V_{T-}$			4.5 V	0.4	0.9	2.1	0.4	2.1	0.4	2.1	V	
		6 V	0.5	1.3	2.5	0.5	2.5	0.5	2.5			
			2 V	1.9	1.998		1.9	SE	1.9			
	VI = VIH or VIL	I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4	2	4.4		V	
VOH			6 V	5.9	5.999		5.9	~	5.9			
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84			
		I _{OH} = -5.2 mA	6 V	5.48	5.8		5.2		5.34			
			2 V		0.002	0.1		0.1		0.1		
		l _{OL} = 20 μA	4.5 V		0.001	0.1		0.1		0.1		
VOL	VI = VIH or VIL		6 V		0.001	0.1		0.1		0.1	V	
		I _{OL} = 4 mA	4.5 V		0.17	0.26		0.4		0.33		
		I _{OL} = 5.2 mA	6 V		0.15	0.26		0.4		0.33		
l	$V_{I} = V_{CC} \text{ or } 0$		6 V		±0.1	±100		±1000		±1000	nA	
ICC	$V_I = V_{CC} \text{ or } 0,$	IO = 0	6 V			2		40		20	μA	
Ci			2 V to 6 V		3	10		10		10	pF	

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

	FROM	TO (OUTPUT)	Vee	T _A = 25°C			SN54HC7032	SN74HC7032		
PARAMETER	(INPUT)		VCC	MIN	TYP	MAX	MIN MAX	MIN MAX	UNIT	
tpd A or B Y		2 V		60	130	195	163			
	Y	4.5 V		18	26	39	33	ns		
			6 V		14	22	2 33	28		
			2 V		28	75	\$ 110	95		
tt		Any	4.5 V		8	15	8 22	19	ns	
			6 V		6	13	2 19	16		

operating characteristics, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance per gate	No load	20	pF

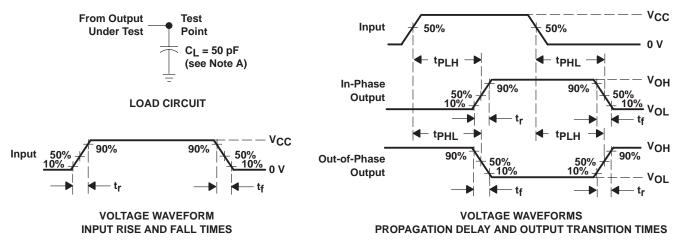
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- NOTES: A. CL includes probe and test-fixture capacitance.
 - B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns, t_f = 6 ns.
 - C. The outputs are measured one at a time, with one input transition per measurement.
 - D. tPLH and tPHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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4-Jun-2007

PACKAGING INFORMATION

NTS

FRUME

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74HC7032D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DT	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DTE4	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032DTG4	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032N	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC7032NE4	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC7032NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC7032NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PACKAGE OPTION ADDENDUM

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*A	I dimensions are nominal												
	Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74HC7032DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	SN74HC7032NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74HC7032DR	SOIC	D	14	2500	346.0	346.0	33.0
SN74HC7032NSR	SO	NS	14	2000	346.0	346.0	33.0

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AB.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.

